

## Dual P-Channel 1.8 V (G-S) MOSFET

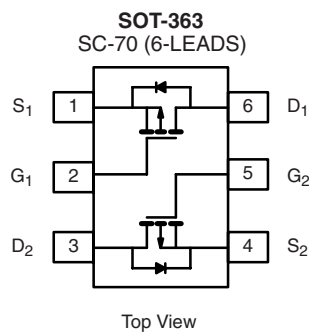
PRODUCT SUMMARY		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
- 8	0.600 at V <sub>GS</sub> = - 4.5 V	± 0.60
	0.850 at V <sub>GS</sub> = - 2.5 V	± 0.50
	1.200 at V <sub>GS</sub> = - 1.8 V	± 0.42

### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 1.8 V Rated
- Compliant to RoHS Directive 2002/95/EC



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available



Marking Code



Lot Traceability  
and Date Code

Part # Code

**Ordering Information:** Si1905DL-T1-E3 (Lead (Pb)-free)  
Si1905DL-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 8		V	
Gate-Source Voltage	V <sub>GS</sub>	± 8			
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	I <sub>D</sub>	T <sub>A</sub> = 25 °C	± 0.60	± 0.57	A
		T <sub>A</sub> = 85 °C	± 0.43	± 0.41	
Pulsed Drain Current	I <sub>DM</sub>	± 1.0			
Continuous Diode Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	- 0.25	- 0.23		
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	T <sub>A</sub> = 25 °C	0.30	0.27	W
		T <sub>A</sub> = 85 °C	0.16	0.14	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	R <sub>thJA</sub>	t ≤ 5 s	360	415	°C/W
		Steady State	400	460	
Maximum Junction-to-Foot (Drain)	R <sub>thJF</sub>	300	350		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

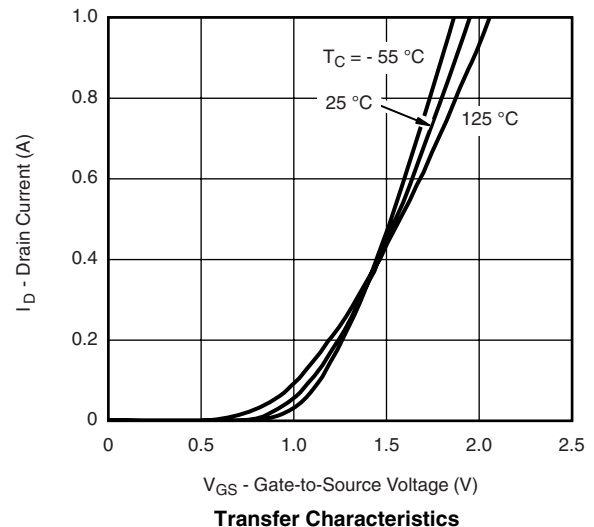
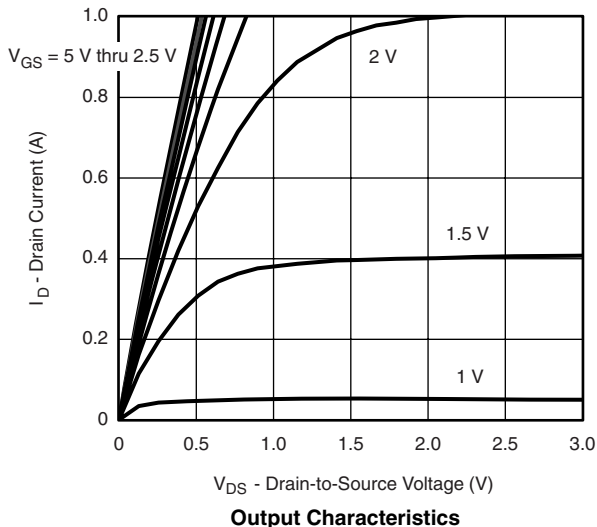
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	-0.45			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -6.4\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -6.4\text{ V}, V_{GS} = 0\text{ V}, T_J = 85\text{ }^\circ\text{C}$			-5	
On-State Drain Current <sup>a</sup>	$I_{D(on)}$	$V_{DS} = -5\text{ V}, V_{GS} = -4.5\text{ V}$	-1.0			A
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -0.57\text{ A}$		0.51	0.600	$\Omega$
		$V_{GS} = -2.5\text{ V}, I_D = -0.48\text{ A}$		0.720	0.850	
		$V_{GS} = -1.8\text{ V}, I_D = -0.20\text{ A}$		1.0	1.200	
Forward Transconductance <sup>a</sup>	$g_{fs}$	$V_{DS} = -10\text{ V}, I_D = -0.57\text{ A}$		1.2		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -0.23\text{ A}, V_{GS} = 0\text{ V}$		-0.8	-1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = -4\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -0.57\text{ A}$		1.5	2.3	nC
Gate-Source Charge	$Q_{gs}$		0.17			
Gate-Drain Charge	$Q_{gd}$		0.16			
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -4\text{ V}, R_L = 8\text{ }\Omega$ $I_D \cong -0.5\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 6\text{ }\Omega$		6	12	ns
Rise Time	$t_r$		25	50		
Turn-Off Delay Time	$t_{d(off)}$		10	20		
Fall Time	$t_f$		10	20		
Source-Drain Reverse Recovery Time	$t_{rr}$		$I_F = -0.23\text{ A}, dI/dt = 100\text{ A}/\mu\text{s}$		20	

Notes:

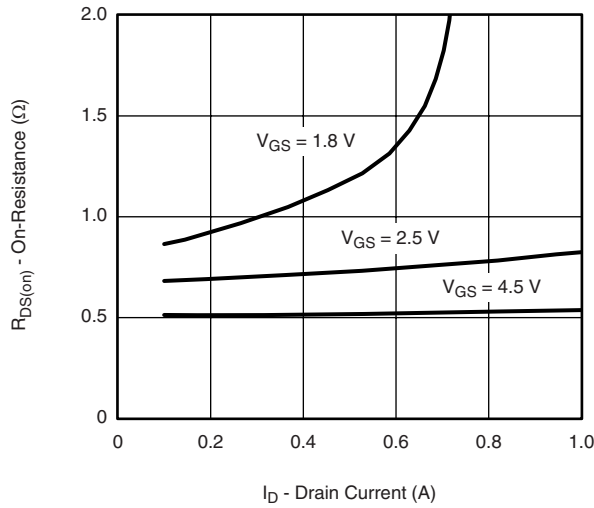
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

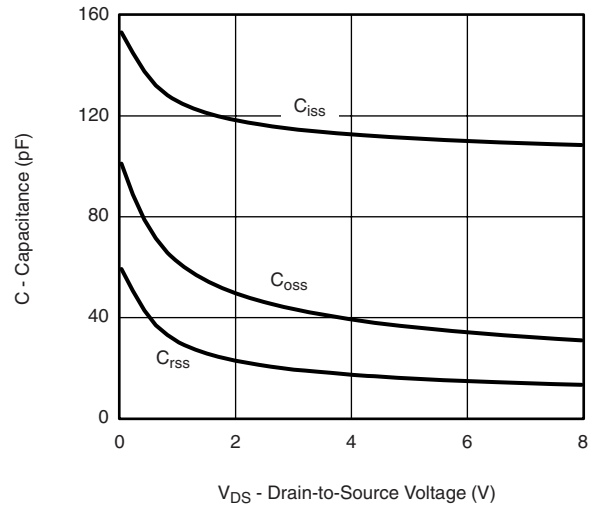
### TYPICAL CHARACTERISTICS $25\text{ }^\circ\text{C}$ , unless otherwise noted



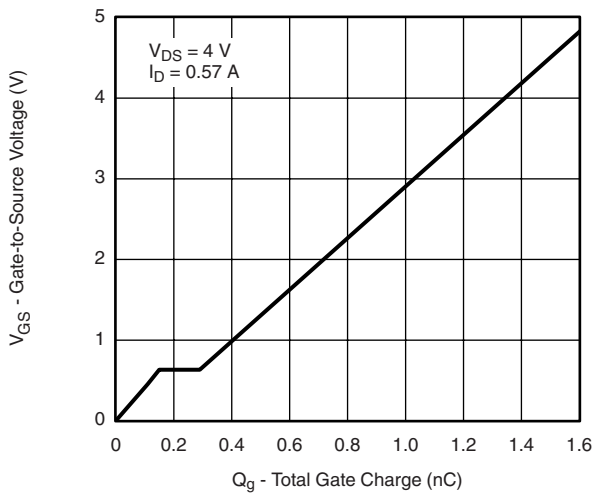
**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



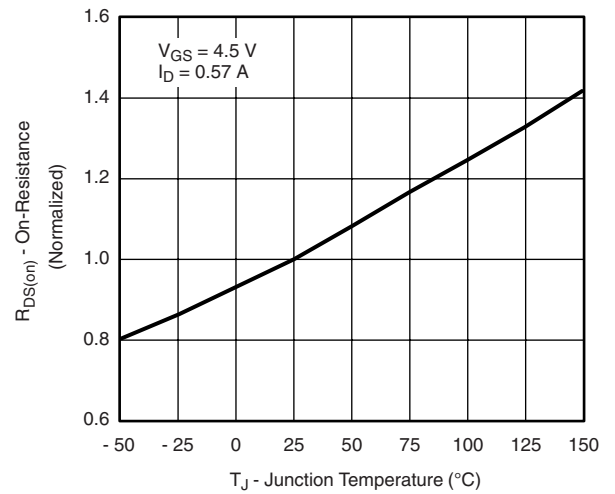
**On-Resistance vs. Drain Current**



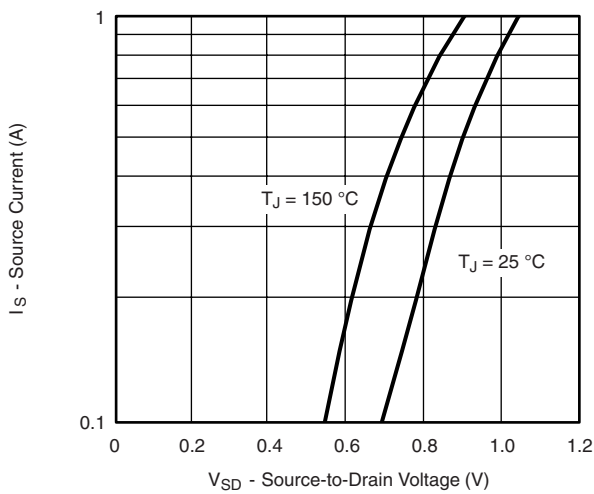
**Capacitance**



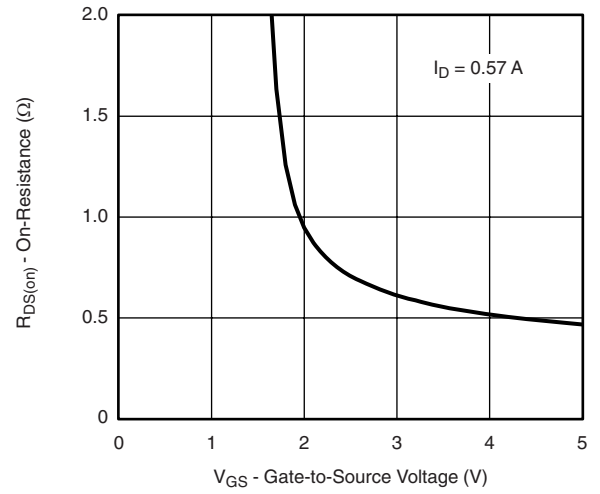
**Gate Charge**



**On-Resistance vs. Junction Temperature**

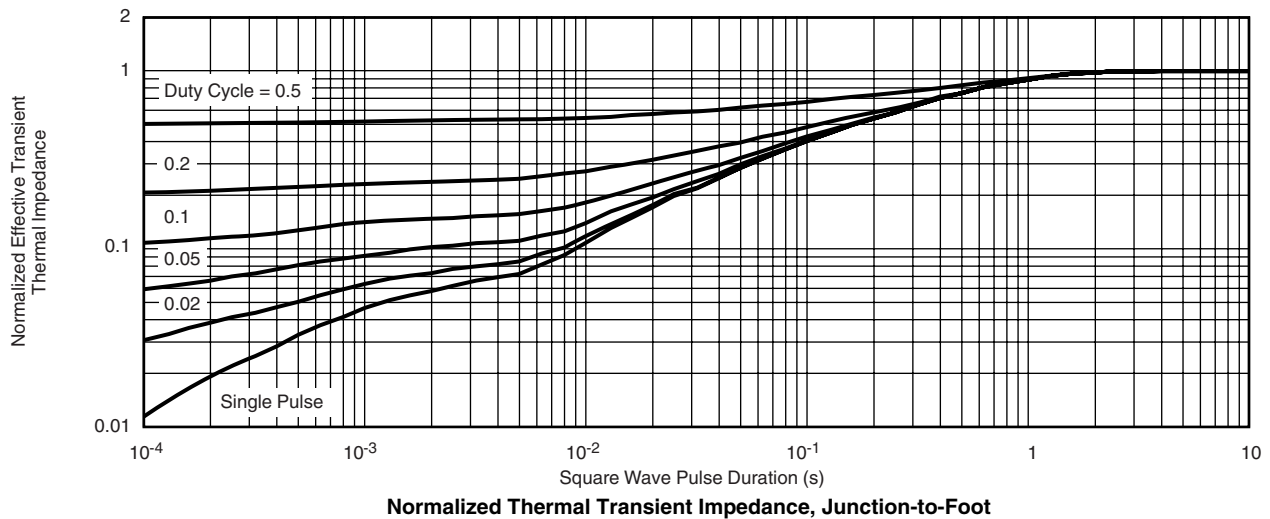
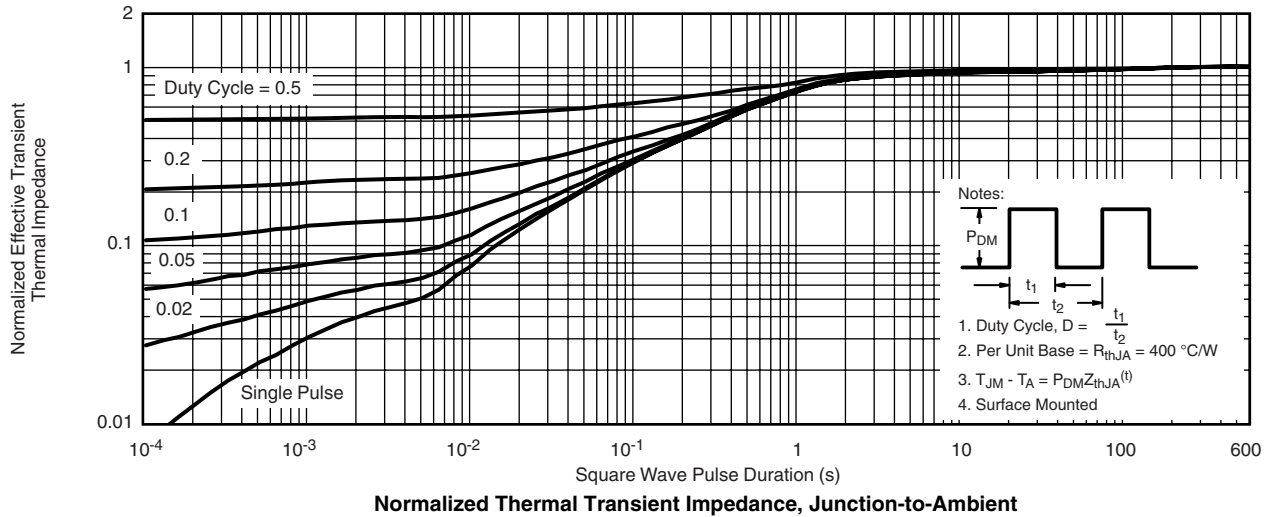
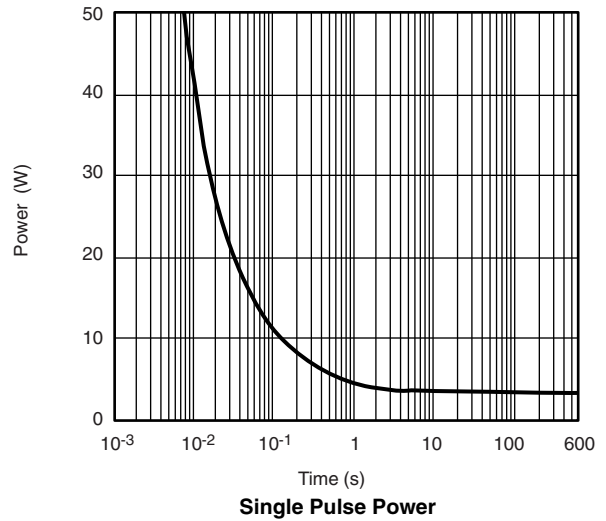
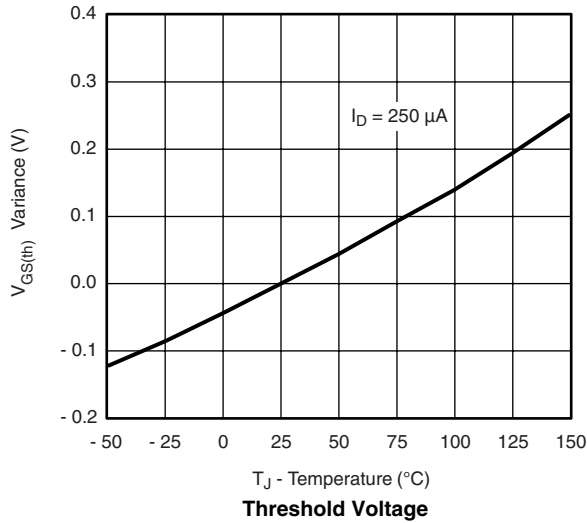


**Source-Drain Diode Forward Voltage**



**On-Resistance vs. Gate-to-Source Voltage**

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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